Cree[®] XLamp[®] XR-E LED



PRODUCT DESCRIPTION

The XLamp[®] XR-E LED is leading the LED lighting revolution with its unprecedented lighting-class brightness, efficacy, lifetime and quality of light. These lighting-class features enable the XLamp XR-E LED to replace many traditional light sources and save money with energy-efficient light and long lifetimes.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing lighting, portable and personal lighting, outdoor lighting, indoor directional lighting, commercial lighting and emergency-vehicle lighting.

FEATURES

- Available in white (2600 K to 10,000 K CCT), blue, royal blue and green
- Maximum drive current: up to 1000 mA
- Maximum junction temperature: 150 °C
- Industry-leading JEDEC standard pre-qualification testing
- Reflow solderable JEDEC
 J-STD-020C compatible
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)



TABLE OF CONTENTS

Characteristics 2
Flux Characteristics - White 3
Flux Characteristics - Color 4
Relative Spectral Power Distribution . 5
Relative Flux vs. Junction
Temperature 6
Electrical Characteristics 7
Relative Flux vs. Current7
Typical Spatial Distribution
Thermal design 8
Reflow Soldering Characteristics 9
Notes10
Mechanical Dimensions12
Tape and reel13
Dry Packaging and Packaging14



CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal Resistance, junction to solder point	°C/W		8	
Viewing Angle (FWHM) - white	degrees		90	
Viewing Angle (FWHM) - royal blue, blue, green	degrees		100	
Temperature Coefficient of Voltage - white, royal blue, blue, green	mV/°C		-4.0	
ESD Classification (HBM per Mil-Std-883D)			Class 2	
DC Forward Current - white \geq 5000 K, royal blue, blue	mA			1000
DC Forward Current - white < 5000 K, green	mA			700
DC Pulse Current (@ 1 kHz, 10% duty cycle)	А			1.8
Reverse Voltage	V			5
Forward Voltage (@ 350 mA)	V		3.3	3.9
Forward Voltage (@ 700 mA)	V		3.5	
Forward Voltage (@ 1000 mA) - white \geq 5000 K, royal blue, blue	V		3.7	
LED Junction Temperature	°C			150



FLUX CHARACTERISTICS (T₁ = 25 °C) - WHITE

The following tables describe the available colors and flux for XR-E LEDs by listing the correlated color temperature or dominant wavelength range for the entire family and by providing several base order codes. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XR Family Binning and Labeling document.

Color	CCT Range			ler Codes nous Flux	Order Code	
	Min.	Max.	Group	Flux (lm)		
			P4	80.6	XREWHT-L1-0000-00901	
			Q2	87.4	XREWHT-L1-0000-00A01	
Cool White	5000 K	10.000 K	Q3	93.9	XREWHT-L1-0000-00B01	
Cool white	5000 K	10,000 K	Q4	100	XREWHT-L1-0000-00C01	
				Q5	107	XREWHT-L1-0000-00D01
			R2	114	XREWHT-L1-0000-00E01	
				Р3	73.9	XREWHT-L1-0000-008E4
			P4	80.6	XREWHT-L1-0000-009E4	
Neutral White	3700 K	5000 K	Q2	87.4	XREWHT-L1-0000-00AE4	
			Q3	93.9	XREWHT-L1-0000-00BE4	
			Q4	100	XREWHT-L1-0000-00CE4	
			N3	56.8	XREWHT-L1-0000-005E7	
			N4	62.0	XREWHT-L1-0000-006E7	
Warm White	2600 K	2600 K 3700 K	P2	67.2	XREWHT-L1-0000-007E7	
			P3	73.9	XREWHT-L1-0000-008E7	
			P4	80.6	XREWHT-L1-0000-009E7	

Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on CRI measurements. See the Measurements section (page 10).
- Typical CRI for Cool White & Neutral White (3700 K 10,000 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.



FLUX CHARACTERISTICS (T₁ = 25 °C) - COLOR

The following tables describe the available colors and flux for XR-E LEDs by listing the correlated color temperature or dominant wavelength range for the entire family and by providing several base order codes. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XR Family Binning and Labeling document.

	Domi	nant Wav	elength F	Range	Base Order Codes Min Radiant Flux							
Color	Min.		Max.		(mW)		Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)						
							D5	465		13	300	XREROY-L1-0000-00801
Royal Blue	D3	450	D5	D5	D5	D5			14	350	XREROY-L1-0000-00901	
											15	425

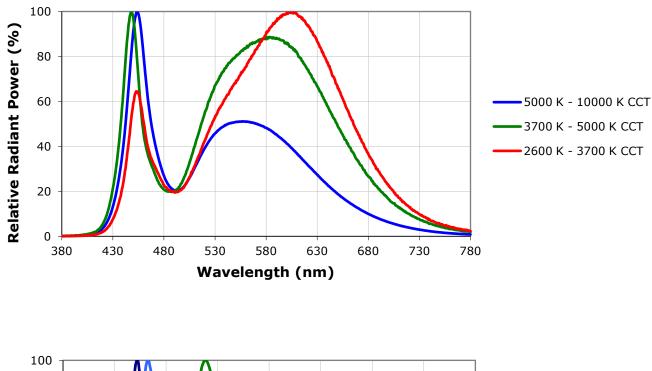
	Domi	nant Wav	elength F	lange	Base Order Codes Min											
Color Min.		Min. Max.		ix.	Luminous Flux (lm)		Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)										
Plue		465	B6 48	40E	J	23.5	XREBLU-L1-0000-00J01									
Blue	B3	405		DO	BO	Вб	Вб	Во	Во	BQ	Вб	вө	80	485	к	30.6

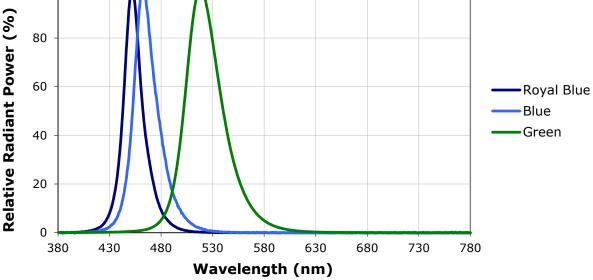
	Domi	nant Wav	elength F	Range		der Codes		
Color	Mi	in.	Ma	ix.	Min. Luminous Flux (Im) Order		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
Green	G2	520	G4	535	Р	67.2	XREGRN-L1-0000-00P01	

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 10).



RELATIVE SPECTRAL POWER DISTRIBUTION

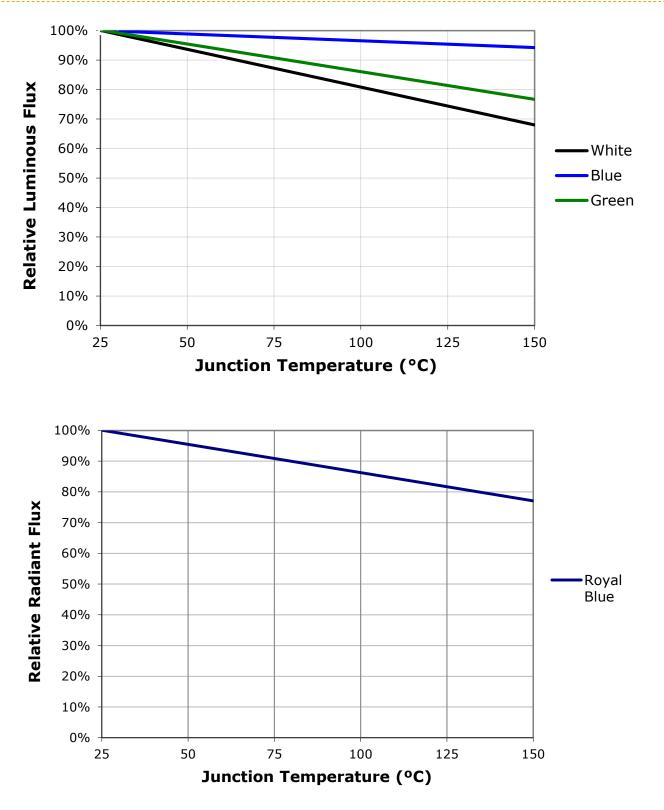








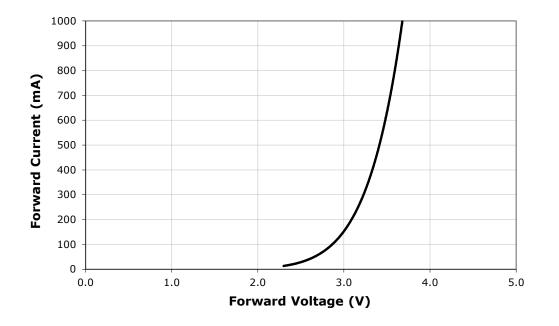
RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)



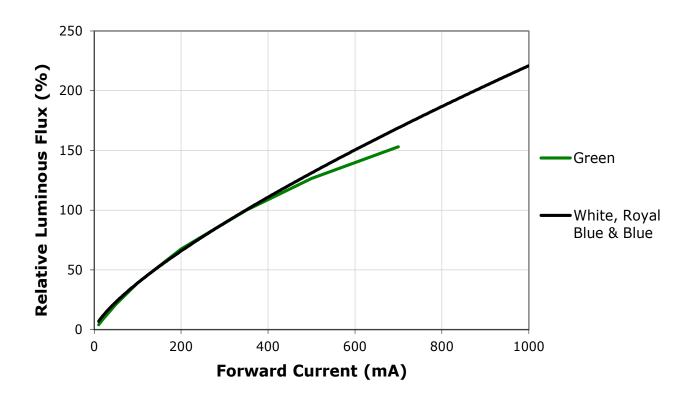
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ELECTRICAL CHARACTERISTICS (T₁ = 25 $^{\circ}$ C)



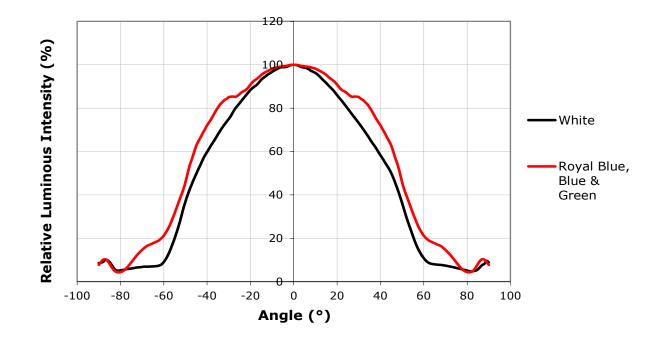
RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)



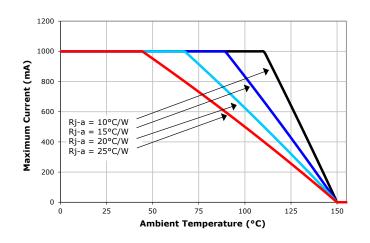
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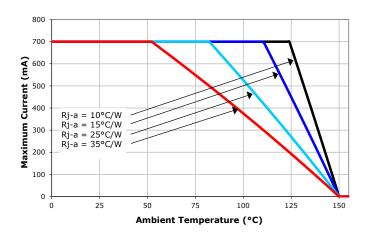


TYPICAL SPATIAL DISTRIBUTION



THERMAL DESIGN



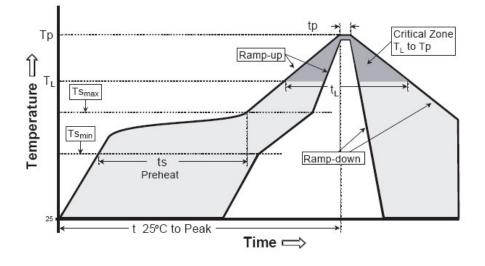




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XR-E LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time $(\boldsymbol{t}_{\!\scriptscriptstyle L})$	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp XR-E LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XR-E LEDs should be handled and stored as MSL 4 per JEDEC J-STD-033, meaning they have limited exposure time before damage to the LED may occur during the soldering operation. The table on the right specifies the maximum exposure time in days depending on temperature and humidity conditions. LEDs with exposure

Toma	Maximum Percent Relative Humidity									
Temp.	30%	40%	50%	60%	70%	80%	90%			
30 °C	9	5	4	3	1	1	1			
25 °C	12	7	5	4	2	1	1			
20 °C	17	9	7	6	2	2	1			

time longer than the specified maximums must be baked according to the baking conditions listed below.

Baking Conditions

It is not necessary to bake all XLamp LEDs. Only the LEDs that meet all of the following criteria must be baked:

- 1. LEDs that have been removed from the original MBP.
- 2. LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.
- 3. LEDs that have not been soldered.

LEDs should be baked at 80 °C for 24 hours. LEDs may be baked on the original reels. Remove LEDs from the MBP before baking. Do not bake parts at temperatures higher than 80 °C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.



NOTES - CONTINUED

Storage Conditions

XLamp LEDs that have been removed from the original MBP but not soldered yet should be stored in a room or cabinet that will maintain an atmosphere of 25 ± 5 °C and no greater than 10% RH (relative humidity). For LEDs stored in these conditions, storage time does not add to exposure time as defined in the Moisture Sensitivity section above.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

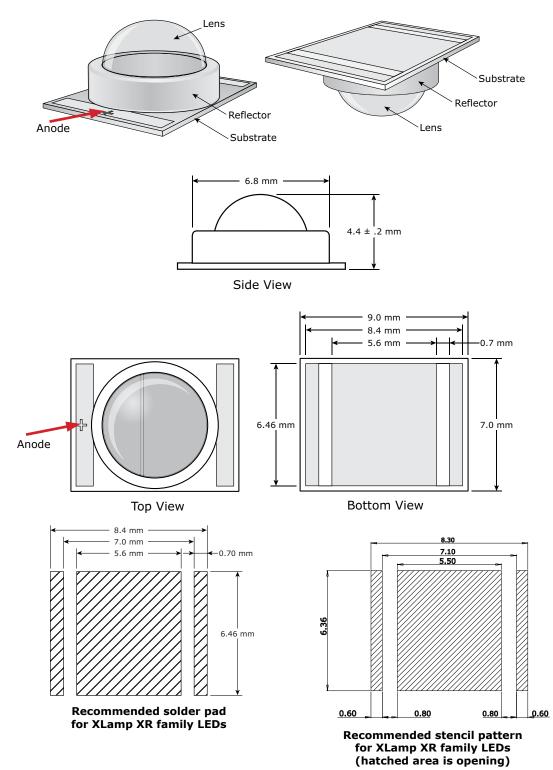
Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.



MECHANICAL DIMENSIONS ($T_A = 25 \text{ °C}$)

All measurements are \pm .1 mm unless otherwise indicated.



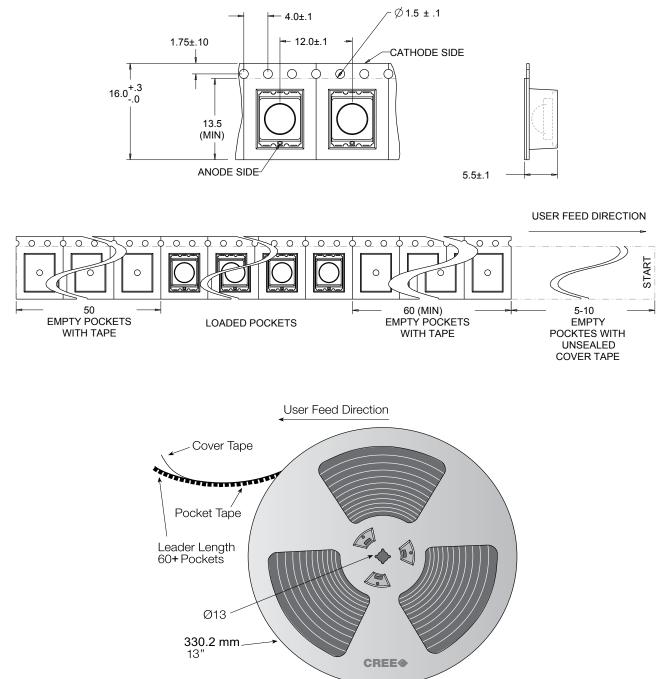
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TAPE AND REEL

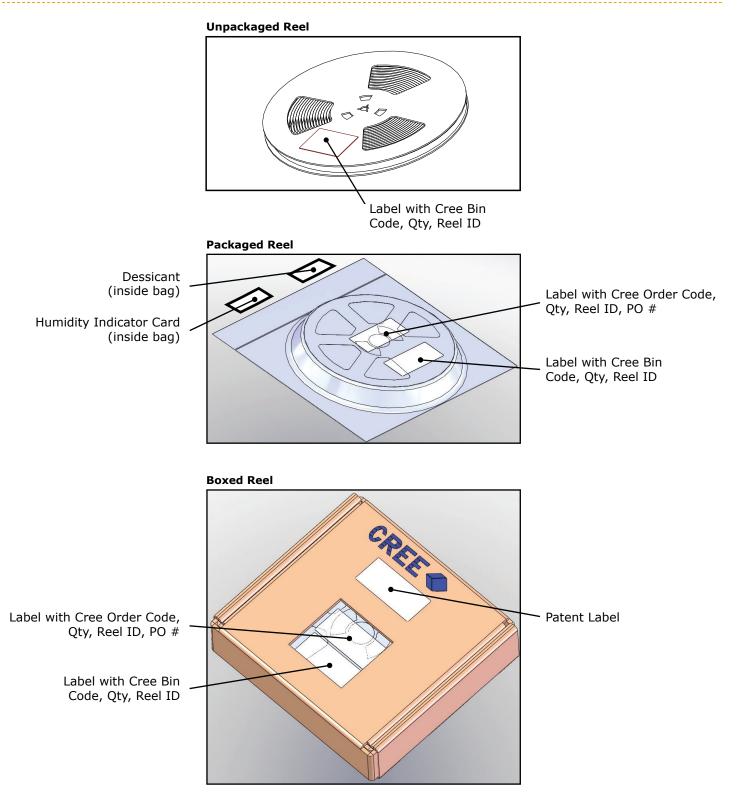
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.





DRY PACKAGING AND PACKAGING



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